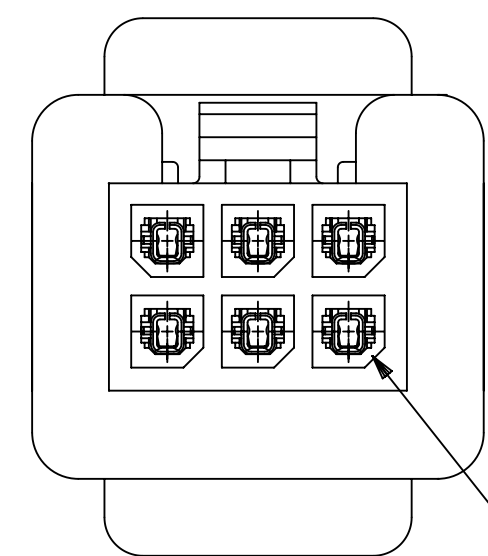
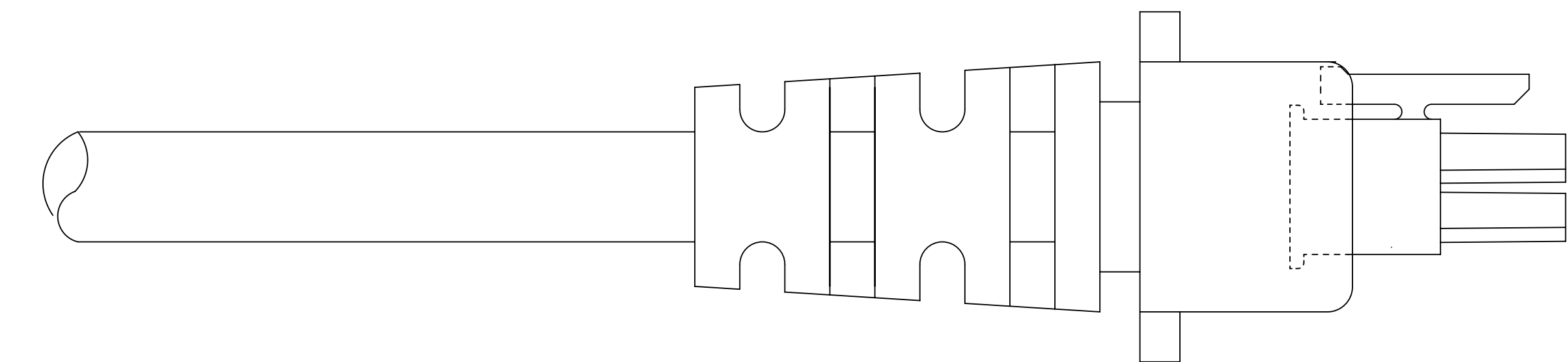
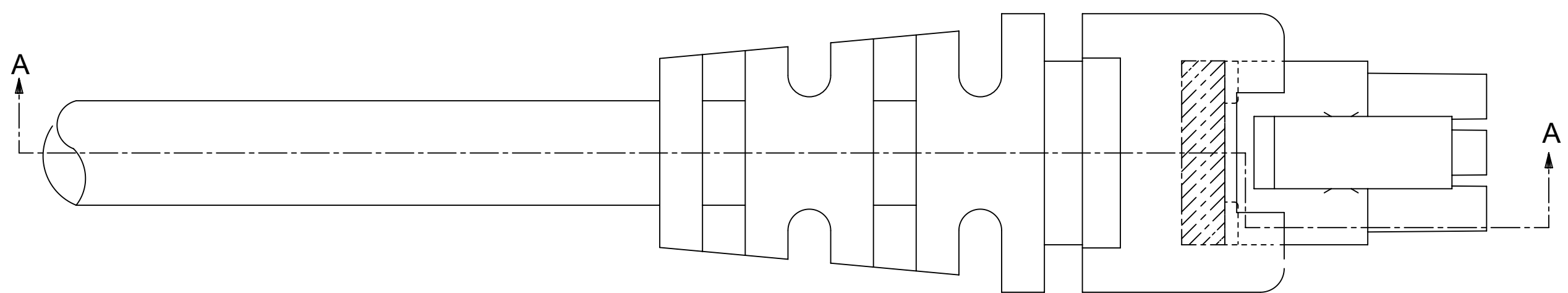


# Molex 430251608 PDF

深圳创唯电子有限公司

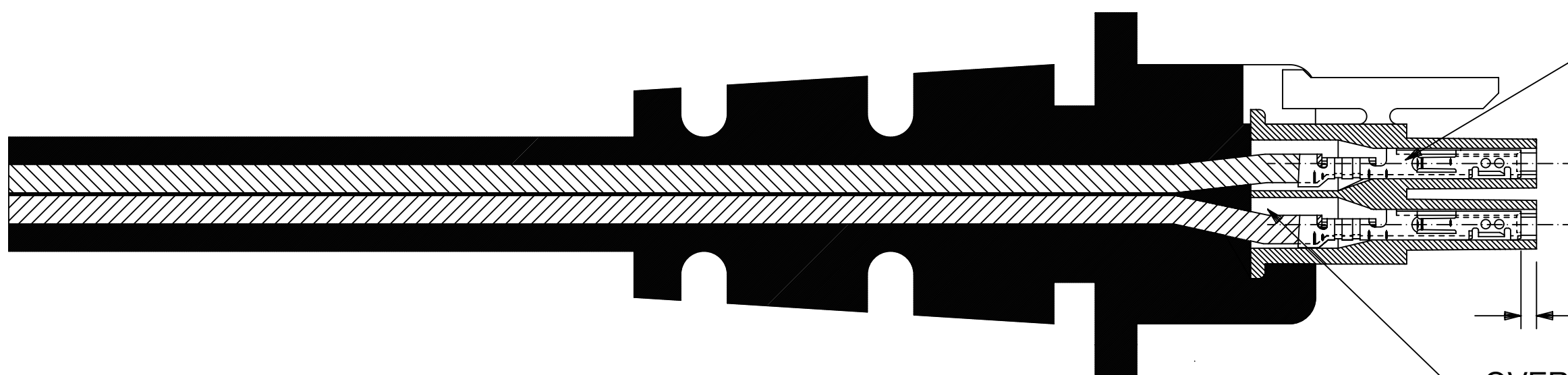
<http://www.molex-connect.com>



OVERMOLDER MAY UTILIZE AT THEIR DISCRETION A CAP SIMILAR TO THIS DESIGN TO PREVENT OVERMOLDING MATERIAL FROM ENTERING WIRE CRIMP AREA OF HOUSING

SUGGESTED MATERIAL FOR CAP:  
MINERAL FILLED PVC

TERMINALS MUST BE CENTERED IN RECEPTACLE PRIOR TO OVERMOLDING



TERMINALS SHOULD BE FULLY SEATED (APPROXIMATELY .030/(0.76) FROM TOP OF SILOS) BEFORE OVERMOLDING

.030  
(0.76) REF

OVERMOLD MATERIAL SHOULD NOT PROCEED PAST WIRE CRIMP

SECTION A-A

NOTES:

- 1) THIS DRAWING APPLIES TO 43025 AND 43645 SERIES RECEPTACLES.
- 2) OVERMOLDING MATERIAL SHOULD NOT ENCAPSULATE THE TERMINAL IN AND AROUND THE WIRE CRIMP AREA.
- 3) TERMINALS MUST BE CENTERED AND PERPENDICULAR INSIDE THE RECEPTACLE HOUSING BEFORE AND AFTER OVERMOLDING.
- 4) DEVICE USED TO CENTER TERMINALS MUST NOT EXCEED .020/(0.51) SQUARE IN ORDER TO PREVENT TERMINAL DEFORMATION.
- 5) OVERMOLD TOOLING MUST NOT DAMAGE INTERNAL OR EXTERNAL FEATURES OF CABLE ASSEMBLY.
- 6) THE OVERMOLDING TEMPERATURES DURING PROCESSING MUST NOT EXCEED 328°F/(164°C)
- 7) REMOVAL OF CABLE ASSEMBLY FROM THE TOOLING MUST NOT IN ANY WAY DAMAGE THE SUPPLIED COMPONENTS.
- 8) MOLEX IS RESPONSIBLE ONLY FOR COMPONENTS SUPPLIED TO THE OVERMOLDER, BUT NOT FOR NONCONFORMANCES INDUCED DURING THE OVERMOLDING PROCESS, SUCH AS OVERMOLD MATERIAL IN THE CONTACT AREA, TERMINALS THAT ARE EITHER OUT OF CENTER OR LACK OF TERMINAL MOBILITY AFTER BEING OVERMOLDED, AND ANY DEFORMATION TO TERMINALS OR HOUSINGS IN GENERAL.

PENDING APPROVAL

THIS DRAWING REPLACES DRAWINGS SDES-43025-1000 AND SDES-43645-1000.

THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX ELECTRONIC TECHNOLOGIES, LLC AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION									
SYMBOLS		DIMENSION UNITS		SCALE		CURRENT REV DESC:			
∇ = 0	∇ = 0	IN/MM	4:1			EC NO: 168740			
∇ = 0	∇ = 0	GENERAL TOLERANCES (UNLESS SPECIFIED)				DRWN: AZAHIROVIC		2017/11/28	
∇ = 0	∇ = 0	MM	INCH			CHK'D: SSOUSEK		2018/06/01	
S = 0	∇ = 0	4 PLACES	±	±			APPR:		
∇ = 0	∇ = 0	3 PLACES	±	±			INITIAL REVISION:		
∇ = 0	∇ = 0	2 PLACES	±	±			DRWN: AZAHIROVIC		2017/11/28
∇ = 0	∇ = 0	1 PLACE	±	±			APPR: FSMITH		2017/11/28
∇ = 0	∇ = 0	0 PLACES	±	±			THIRD ANGLE PROJECTION		
∇ = 0	∇ = 0	ANGULAR TOL	±	°			DRAWING		SERIES
∇ = 0	∇ = 0	DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				C-SIZE		43025	
								MATERIAL NUMBER	
								CUSTOMER	
								SHEET NUMBER	
								1 OF 1	

**molex**

MICRO-FIT(3.0) OVERMOLDING SPECIFICATION

DOCUMENT NUMBER: 430250000-AS

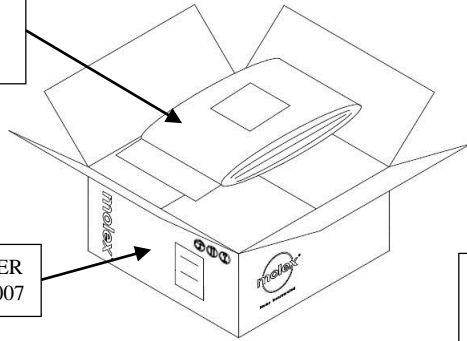
DOC TYPE: PS, DOC PART: 000, REVISION: A

CUSTOMER: GENERAL MARKET

DOCUMENT STATUS	RQ	RELEASE DATE	
-----------------	----	--------------	--

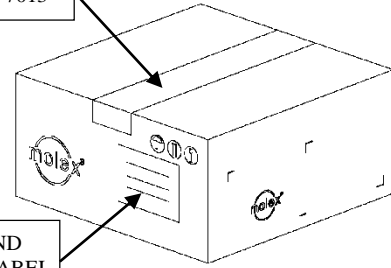
# molex PRODUCT SPECIFICATION

ANTISTATIC BAG  
PER  
ES-40000-7011  
SEE CHART



CARTON PER  
ES-40000-7007

ADHESIVE TAPE  
PER ES-40000-7013



PRODUCT I.D. AND  
SAFETY AGENCY LABEL  
PER ES-40000-7012

- 1) PARTS ARE TO BE BULK PACKED IN ANTISTATIC BAGS IN QUANTITIES SHOWN IN CHART. BAG PART NUMBER AND SIZE ARE LISTED FOR REFERENCE ONLY. SEE SHEET 2 FOR ALTERNATE BAG PACKAGING METHOD.
- 2) PARTS MOLDED IN NYLON ARE TO BE MOISTURIZED PER AS-45499-001 (EXCEPTION: PARTS WITHOUT LATCH). PARTS MOLDED IN PBT DO NOT REQUIRE TO BE MOISTURIZED.
- 3) MOISTURIZATION BAGS ARE TO BE PREPARED BY FIRST ADDING WATER TO 46996-2011 (885961016) PAD AS OUTLINED IN AS-45499-001, THEN INSERTING PAD INTO 46996-2010 (885960969) MOISTURIZATION BAG AND SEALING ZIP LOCK. WATER IS NOT TO BE ADDED DIRECTLY TO THE PARTS.
- 4) MOISTURIZATION BAG IS TO BE INCLUDED IN PARTS BAG AND PARTS BAG IS TO BE CLOSED.
- 5) BAGGED PARTS TO BE PLACED IN CARTON AS INDICATED.
- 6) CARTON 88596-1634 MAY BE SUBSTITUTED FOR 30907-3001.

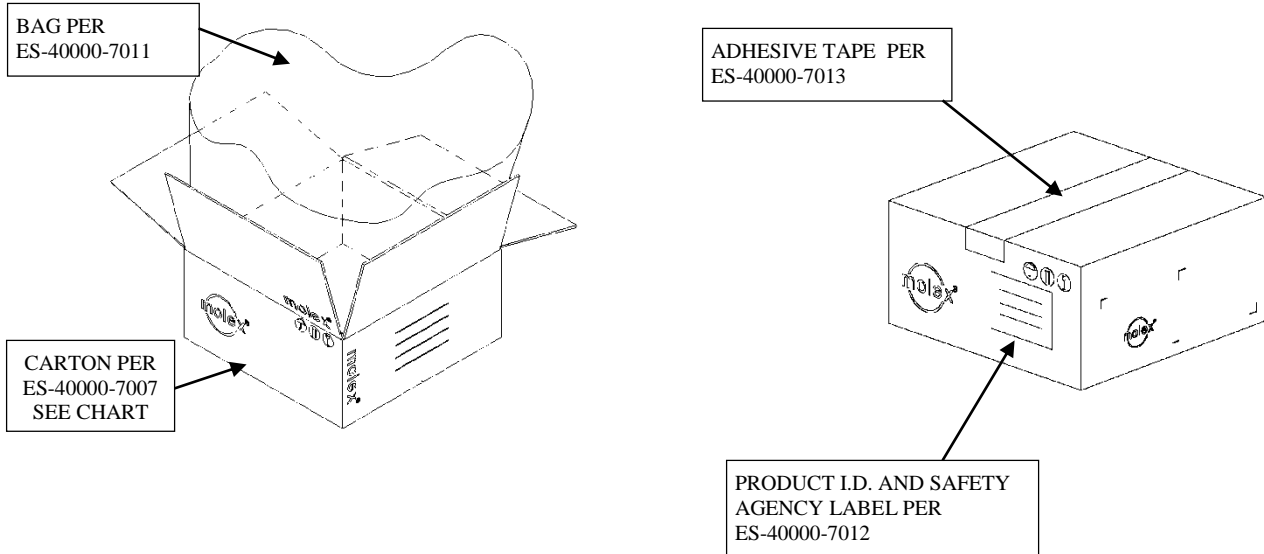
CKT SIZE	MATERIAL NO.	BAG PART NO. OR EQUIVALENT (SEE NOTE 1)	APPROXIMATE BAG SIZE (SEE NOTE 1)	PARTS PER BAG	CARTON PART NO. OR EQUIVALENT	BAGS PER CARTON	PARTS PER CARTON (SPQ)
2	43025-02xx	45654-0002	18 X 20	5000	96707-1003 OR 96707-0003	1	5000
4	43025-04xx	45654-0002	18 X 20	2500		1	2500
6	43025-06xx						
8	43025-08xx						
10	43025-10xx	45654-0001	12 X 18	1500	30907-3001	1	1500
12	43025-12xx	45654-0001	12 X 18	1500	30907-3001	1	1500
14	43025-14xx	45654-0002	18 X 20	1500	30907-3001	1	1500
16	43025-16xx	45654-0002	18 X 20	1500	30907-3001	1	1500
18	43025-18xx	45654-0002	18 X 20	1000	30907-3001	1	1000
20	43025-20xx	45654-0002	18 X 20	1000	30907-3001	1	1000
22	43025-22xx						
24	43025-24xx						

CARTON 88596-1608 MAY BE SUBSTITUTED FOR 96707-0015.

REVISION: <b>E4</b>	ECR/ECN INFORMATION: EC No: <b>605257</b> DATE: <b>2018/10/01</b>	TITLE: <b>BULK PACKAGING SPECIFICATION MICROFIT 43025 SERIES</b>	SHEET No. <b>1 of 2</b>
DOCUMENT NUMBER: <b>PK-43025-001</b>	CREATED / REVISED BY: <b>SALHAMY</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

# molex PRODUCT SPECIFICATION

## ALTERNATE BAG PACKAGING METHOD



CKT SIZE	MATERIAL NO.	LINER BAG PART NO. OR EQUIVALENT (SEE NOTE 1)	CARTON PART NO. OR EQUIVALENT	PARTS PER BAG/CARTON (SPQ)
2	43025-02xx			
4	43025-04xx			
6	43025-06xx	31300-6440	30907-3001	3000
8	43025-08xx	31300-6440	30907-3001	2500
10	43025-10xx	31300-6440	30907-3001	1500
12	43025-12xx	31300-6440	30907-3001	1500
14	43025-14xx	31300-6440	30907-3001	1500
16	43025-16xx	31300-6440	30907-3001	1500
18	43025-18xx	31300-6440	30907-3001	1000
20	43025-20xx	31300-6440	30907-3001	1000
22	43025-22xx	31300-8790	96707-0015	2000
24	43025-24xx	31300-8790	96707-0015	2000

REVISION: <b>E4</b>	ECR/ECN INFORMATION: EC No: <b>605257</b> DATE: <b>2018/10/01</b>	TITLE: <b>BULK PACKAGING SPECIFICATION MICROFIT 43025 SERIES</b>	SHEET No. <b>2 of 2</b>
DOCUMENT NUMBER: <b>PK-43025-001</b>	CREATED / REVISED BY: <b>SALHAMY</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## Micro-Fit (3.0) Connector System (Wire to Wire & Wire to Board)

### 1.0 SCOPE

This Test Specification covers the 3.00 mm (.118 inch) centerline (pitch) connector series terminated with 20-30 AWG wire using crimp technology.

### 2.0 PRODUCT DESCRIPTION

#### 2.1 PRODUCT NAME, SERIES, AND PART NUMBER(S)

- Micro-Fit (3.0) Receptacle Series : 43025, 43645, 44133 (BMI)
- Micro-Fit (3.0) Plug Series : 43020, 43640, 44300 (BMI)
- Micro-Fit (3.0) Right Angle & Vertical Header Series : 43045, 43650, 44067
- Micro-Fit (3.0) Compliant Pin Vertical Header Series : 44914
- Micro-Fit (3.0) Female Crimp Terminal Series : 43030
- Micro-Fit (3.0) Male Crimp Terminal Series : 43031
- Micro-Fit (3.0) Female Crimp Terminal with Lubricant : 45773

#### 2.1.1 SERIES NUMBERS TESTED

- Micro-Fit (3.0) Receptacle : 43025
- Micro-Fit (3.0) Plug : 43020
- Micro-Fit (3.0) Right Angle & Vertical Headers : 43045
- Micro-Fit (3.0) Female Crimp Terminal : 43030
- Micro-Fit (3.0) Male Crimp Terminal : 43031

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

See the appropriate sales drawings for information on dimensions, materials, plating, and markings.

#### 2.3 PRODUCT SPECIFICATION TITLE AND DOCUMENT NUMBER

- Product Specification Micro-Fit Dual Row Connectors  
Document Number: PS-43045
- Product Specification Micro-Fit Single Row Connectors  
Document Number: PS-43650
- Product Specification Micro-Fit (3.0) BMI Floating Connector System  
Document Number: PS-44300-001

### 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

#### 3.1 TESTING PROCEDURES AND SEQUENCES

EIA-364-1000.01

<u>REVISION:</u> <b>A2</b>	<u>ECR/ECN INFORMATION:</u> EC No: <b>109530</b> DATE: <b>2016 / 10 /18</b>	<u>TITLE:</u> <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	<u>SHEET No.</u> <b>1 of 10</b>
<u>DOCUMENT NUMBER:</u> <b>TS-43045-001</b>		<u>CREATED / REVISED BY:</u> <b>JDFOX</b>	<u>CHECKED BY:</u> <b>SSOUSEK</b>
		<u>APPROVED BY:</u> <b>FSMITH</b>	

### 3.2 OTHER DOCUMENTS AND SPECIFICATIONS

None

### 4.0 QUALIFICATION

Laboratory conditions and sample selection are in accordance with **EIA-364**.

### 5.0 PERFORMANCE RESULTS

#### 5.1 ELECTRICAL PERFORMANCE RESULTS

##### WIRE TO WIRE CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>1A</b>	CONTACT RESISTANCE (LOW LEVEL)	Initial **	10 milliohms MAXIMUM	19.95 mΩ	19.74 mΩ	20.40 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	-0.23 mΩ	-0.03 mΩ	0.67 mΩ
		After Temperature Life Δ mΩ	20 milliohms MAXIMUM	0.38 mΩ	0.08 mΩ	1.01 mΩ
		After Reseating Δ mΩ	20 milliohms MAXIMUM	0.25 mΩ	-0.53 mΩ	1.32 mΩ

NOTE : \*\* APPROXIMATELY 16.6 mΩ OF THE MEASUREMENT VALUE IS ATTRIBUTED TO THE BULK RESISTANCE OF THE 13 INCHES OF WIRE USED IN SAMPLE PREPARATION.

##### WIRE TO BOARD CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>1B</b>	CONTACT RESISTANCE (LOW LEVEL)	Initial	10 milliohms MAXIMUM	4.75 mΩ	4.55 mΩ	4.98 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	-0.23 mΩ	-0.03 mΩ	0.67 mΩ
		After Temperature Life Δ mΩ	20 milliohms MAXIMUM	0.38 mΩ	0.08 mΩ	1.01 mΩ
		After Reseating Δ mΩ	20 milliohms MAXIMUM	0.25 mΩ	-0.53 mΩ	1.32 mΩ

NOTE : SEE APPENDIX "A" FOR TEST SEQUENCE DESCRIPTION.

REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 /18	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>2 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## 5.1 ELECTRICAL PERFORMANCE RESULTS (continued)

### WIRE TO WIRE CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>2A</b>	Contact Resistance (Low Level)	Initial **	10 milliohms MAXIMUM	20.01 mΩ	19.59 mΩ	23.29 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	0.19 mΩ	-0.02 mΩ	0.64 mΩ
		After Thermal Shock Δ mΩ	20 milliohms MAXIMUM	0.34 mΩ	0.08 mΩ	0.74 mΩ
		After Cyclic Humidity Δ mΩ	20 milliohms MAXIMUM	0.62 mΩ	0.14 mΩ	1.77 mΩ
		After Reseating Δ mΩ	20 milliohms MAXIMUM	0.61 mΩ	0.11 mΩ	3.09 mΩ

NOTE : \*\* APPROXIMATELY 16.6 mΩ OF THE MEASUREMENT VALUE IS ATTRIBUTED TO THE BULK RESISTANCE OF THE 13 INCHES OF WIRE USED IN SAMPLE PREPARATION.

### WIRE TO BOARD CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>2B</b>	Contact Resistance (Low Level)	Initial	10 milliohms MAXIMUM	4.75 mΩ	4.55 mΩ	4.98 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	0.42 mΩ	-0.02 mΩ	2.03 mΩ
		After Thermal Shock Δ mΩ	20 milliohms MAXIMUM	1.56 mΩ	0.25 mΩ	5.71 mΩ
		After Cyclic Humidity Δ mΩ	20 milliohms MAXIMUM	1.28 mΩ	0.15 mΩ	4.60 mΩ
		After Reseating Δ mΩ	20 milliohms MAXIMUM	2.19 mΩ	0.23 mΩ	8.04 mΩ

NOTE : SEE APPENDIX "A" FOR TEST SEQUENCE DESCRIPTION

REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 /18	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>3 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## 5.1 ELECTRICAL PERFORMANCE RESULTS (continued)

### WIRE TO BOARD CONFIGURATION – 2 CIRCUIT VERSION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
3A	Contact Resistance (Low Level)	Initial **	10 milliohms MAXIMUM	10.26 mΩ	10.17 mΩ	10.46 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	0.75 mΩ	0.16 mΩ	1.57 mΩ
		After Temperature Life Pre-Conditioned Δ mΩ	20 milliohms MAXIMUM	1.88 mΩ	0.58 mΩ	3.77 mΩ
		After Vibration Δ mΩ	20 milliohms MAXIMUM	1.28 mΩ	0.15 mΩ	4.60 mΩ
		No Discontinuity	Discontinuity < 1 microsecond			

NOTE : \*\* APPROXIMATELY 7.8 mΩ OF THE MEASUREMENT VALUE IS ATTRIBUTED TO THE BULK RESISTANCE OF THE 6 INCHES OF WIRE USED IN SAMPLE PREPARATION.

### WIRE TO BOARD CONFIGURATION –12 CIRCUIT VERSION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
3B	Contact Resistance (Low Level)	Initial **	10 milliohms MAXIMUM	10.24 mΩ	9.85 mΩ	10.52 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	0.41 mΩ	0.14 mΩ	2.13 mΩ
		After Temperature Life Pre-Conditioned Δ mΩ	20 milliohms MAXIMUM	0.81 mΩ	0.16 mΩ	3.68 mΩ
		After Vibration Δ mΩ	20 milliohms MAXIMUM	1.14 mΩ	0.25 mΩ	3.56 mΩ
		No Discontinuity	Discontinuity < 1 microsecond			

NOTES : \*\* APPROXIMATELY 7.8 mΩ OF THE MEASUREMENT VALUE IS ATTRIBUTED TO THE BULK RESISTANCE OF THE 6 INCHES OF WIRE USED IN SAMPLE PREPARATION.

SEE APPENDIX "A" FOR TEST SEQUENCE DESCRIPTION

REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 /18	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>4 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



## 5.1 ELECTRICAL PERFORMANCE RESULTS (continued)

### WIRE TO WIRE CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
4A	Contact Resistance (Low Level)	Initial **	10 milliohms MAXIMUM	20.07 mΩ	19.95 mΩ	20.50 mΩ
		After Durability Δ mΩ	20 milliohms MAXIMUM	0.31 mΩ	-0.02 mΩ	0.72 mΩ
		After Temperature Life Pre-Conditioned Δ mΩ	20 milliohms MAXIMUM	0.34 mΩ	0.07 mΩ	0.97 mΩ
		Thermal Cycling 167 Hours Δ mΩ	20 milliohms MAXIMUM	0.42 mΩ	0.10 mΩ	2.01 mΩ
		Thermal Cycling 334 Hours Δ mΩ	20 milliohms MAXIMUM	0.41 mΩ	-0.06 mΩ	1.03 mΩ
		Thermal Cycling 500 Hours Δ mΩ	20 milliohms MAXIMUM	0.64 mΩ	0.03 mΩ	2.79 mΩ
		After Reseating Δ mΩ	20 milliohms MAXIMUM	0.54 mΩ	0.14 mΩ	2.45 mΩ

NOTES : \*\* APPROXIMATELY 16.6 mΩ OF THE MEASUREMENT VALUE IS ATTRIBUTED TO THE BULK RESISTANCE OF THE 13 INCHES OF WIRE USED IN SAMPLE PREPARATION.

SEE APPENDIX "A" FOR TEST SEQUENCE DESCRIPTION

REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 /18	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>5 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## 5.1 ELECTRICAL PERFORMANCE RESULTS (continued)

### WIRE TO BOARD CONFIGURATION

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>4B</b>	Contact Resistance (Low Level)	Initial	10 milliohms MAXIMUM	<b>4.78 mΩ</b>	<b>4.56 mΩ</b>	<b>5.53 mΩ</b>
		After Durability Δ mΩ	20 milliohms MAXIMUM	<b>0.48 mΩ</b>	<b>0.06 mΩ</b>	<b>2.35 mΩ</b>
		After Temperature Life Pre-Conditioned Δ mΩ	20 milliohms MAXIMUM	<b>1.07 mΩ</b>	<b>0.13 mΩ</b>	<b>5.80 mΩ</b>
		Thermal Cycling 167 Hours Δ mΩ	20 milliohms MAXIMUM	<b>1.38 mΩ</b>	<b>0.30 mΩ</b>	<b>4.68 mΩ</b>
		Thermal Cycling 334 Hours Δ mΩ	20 milliohms MAXIMUM	<b>1.63 mΩ</b>	<b>0.31 mΩ</b>	<b>5.17 mΩ</b>
		Thermal Cycling 500 Hours Δ mΩ	20 milliohms MAXIMUM	<b>3.04 mΩ</b>	<b>0.69 mΩ</b>	<b>8.51 mΩ</b>
		After Reseating Δ mΩ	20 milliohms MAXIMUM	<b>3.48 mΩ</b>	<b>0.41 mΩ</b>	<b>8.94 mΩ</b>

NOTE : SEE APPENDIX "A" FOR TEST SEQUENCE DESCRIPTION

REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 /18</b>	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>6 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## 5.1 ELECTRICAL PERFORMANCE RESULTS (continued)

ITEM	DESCRIPTION	WIRE GAUGE	REQUIREMENT	AMPERAGE
5	Temperature Rise & Current Cycling	30 AWG	30°C Max. Temp. Rise	2.5 Amps
		26 AWG	30°C Max. Temp. Rise	3.0 Amps
		24 AWG	30°C Max. Temp. Rise	4.0 Amps
		20 AWG	30°C Max. Temp. Rise	5.5 Amps

## 5.2 MECHANICAL PERFORMANCE RESULTS

ITEM	DESCRIPTION	Wire Gauge	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
6	Wire Pullout Force (Newtons)	20 AWG	57.8 N Minimum	127.4	117.5	134.7
		22 AWG	35.6 N Minimum	86.1	80.2	90.4
		24 AWG	22.2 N Minimum	53.6	44.7	58.08
		26 AWG	13.3 N Minimum	36.1	33.8	38.3
		28 AWG	8.9 N Minimum	21.1	18.1	23.2
		30 AWG	6.6 N Minimum	18.2	13.5	24.6

ITEM	DESCRIPTION	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
7	Contact Normal Force (grams)	275 g Min	331 g	322 g	343 g

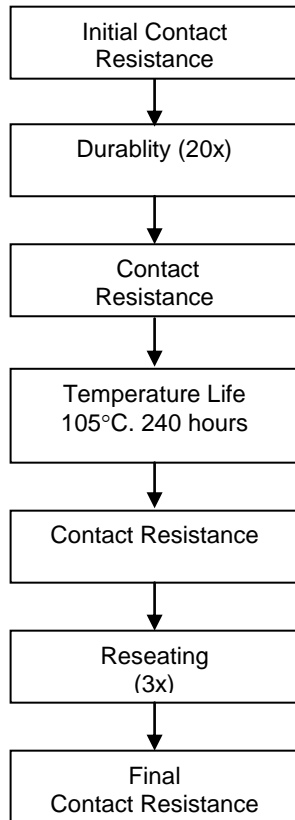
REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 /18	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>7 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

**APPENDIX A**  
TEST SEQUENCES

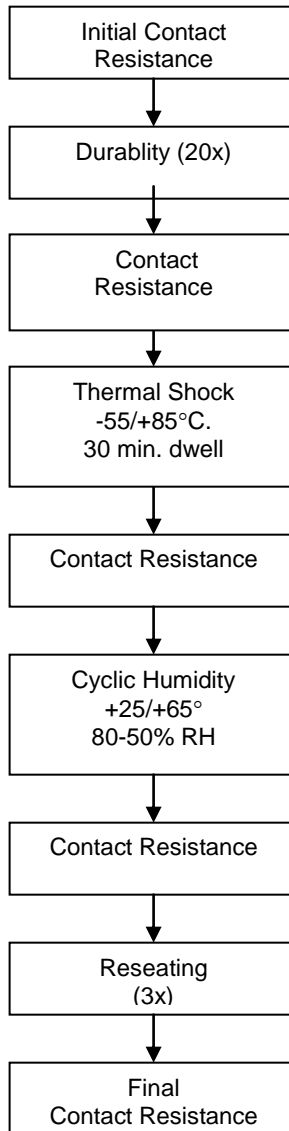
<b>REVISION:</b> <b>A2</b>	<b>ECR/ECN INFORMATION:</b> EC No: <b>109530</b> DATE: <b>2016 / 10 /18</b>	<b>TITLE:</b> <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	<b>SHEET No.</b> <b>8 of 10</b>
<b>DOCUMENT NUMBER:</b> <b>TS-43045-001</b>	<b>CREATED / REVISED BY:</b> <b>JDFOX</b>	<b>CHECKED BY:</b> <b>SSOUSEK</b>	<b>APPROVED BY:</b> <b>FSMITH</b>

## A.1 TEST SEQUENCES

### SEQUENCE 1 1A Wire to Wire 1B Wire to Board



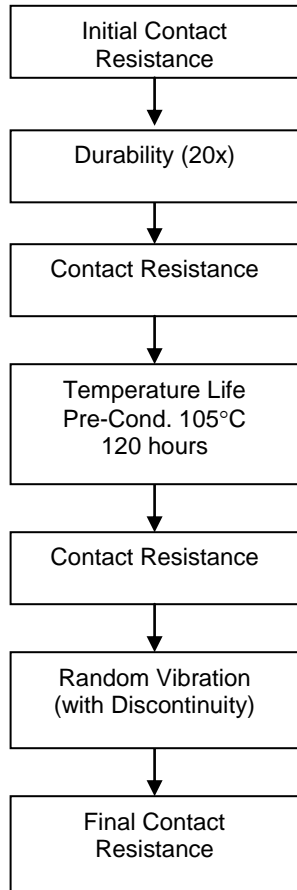
### SEQUENCE 2 2A Wire to Wire 2B Wire to Board



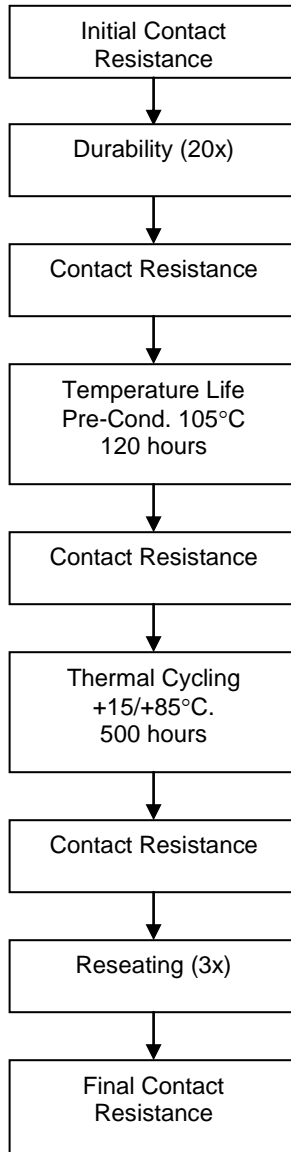
REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 /18</b>	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>9 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

## A.1 TEST SEQUENCES (continued)

### SEQUENCE 3 3A Wire to Wire 3B Wire to Board



### SEQUENCE 4 4A Wire to Wire 4B Wire to Board

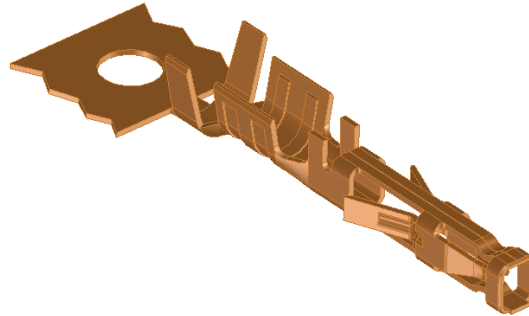


REVISION: <b>A2</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 /18</b>	TITLE: <b>TEST SUMMARY MICRO-FIT (3.0) CONNECTORS</b>	SHEET No. <b>10 of 10</b>
DOCUMENT NUMBER: <b>TS-43045-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## LOW FORCE MICRO-FIT SERIES (46235)



### 1.0 SCOPE

This Test Summary covers the 3.00 mm (.118 inch) centerline (pitch) receptacles terminated with 46235 low force crimp terminals when mated with either printed circuit board (PCB) headers or plugs terminated with 20 to 30 AWG wire using crimp technology.

### 2.0 PRODUCT DESCRIPTION

#### 2.1 PRODUCT NAME, SERIES, AND PART NUMBER(S)

- Micro-Fit (3.0) Receptacle Series : 43025, 43645, 44133 (BMI)
- Micro-Fit (3.0) Plug Series : 43020, 43640, 44300 (BMI)
- Micro-Fit (3.0) Right Angle & Vertical Header Series : 43045, 43650, 44067
- Micro-Fit (3.0) Compliant Pin Vertical Header Series : 44914
- Micro-Fit (3.0) Female Crimp Terminal Series : 46235
- Micro-Fit (3.0) Male Crimp Terminal Series : 43031

#### 2.1.1 SERIES NUMBERS TESTED

- Micro-Fit (3.0) Receptacle : 43025
- Micro-Fit (3.0) Plug : 43020
- Micro-Fit (3.0) Right Angle & Vertical Headers : 43045
- Micro-Fit (3.0) Female Crimp Terminal : 46235
- Micro-Fit (3.0) Male Crimp Terminal : 43031

#### 2.2 DIMENSIONS, MATERIALS, PLATINGS AND MARKINGS

Refer to the appropriate sales drawings for information on dimensions, materials, platings and markings.

#### 2.3 PRODUCT SPECIFICATION TITLE AND DOCUMENT NUMBER

Title: Product Specification for Micro-fit Low Mate Force Connector System  
Document No.: PS-46235-001

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>1 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 3.0 APPLICABLE DOCUMENTS AND SPECIFICATIONS

### 3.1 TESTING SEQUENCES AND PROCEDURES

Reference Appendix 1

### 3.2 OTHER DOCUMENTS AND SPECIFICATIONS

SD-46235-001

PS-46235-001

## 4.0 QUALIFICATION

Laboratory conditions and sample selection are in accordance with EIA-364.

## 5.0 PERFORMANCE

### 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS

(Note that measured LLCR values are for one mated interface)

DESCRIPTION	WIRE GAUGE	REQUIREMENT	AMPERAGE
Temperature Rise & Current Cycling	30 awg	30° C Max. Temperature Rise	2.5 amps (2 circuit)
	26 awg	30° C Max. Temperature Rise	3.0 amps (2 circuit)
	24 awg	30° C Max. Temperature Rise	4.0 amps (2 circuit)
	20 awg	30° C Max. Temperature Rise	5.5 amps (2 circuit)

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>2 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>





# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  1</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.83</b> mΩ	<b>12.03</b> mΩ	<b>13.28</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.03</b> mΩ	<b>-0.40</b> mΩ	<b>0.63</b> mΩ
		After Temp Life (240 hrs. @ 105°C)	20 mΩ MAXIMUM*	<b>0.06</b> mΩ	<b>-0.39</b> mΩ	<b>0.61</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>0.07</b> mΩ	<b>-0.32</b> mΩ	<b>0.81</b> mΩ

\* change from initial

WIRE TO WIRE						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  1</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.70</b> mΩ	<b>11.82</b> mΩ	<b>13.52</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.12</b> mΩ	<b>-0.31</b> mΩ	<b>0.78</b> mΩ
		After Temp Life (240 hrs. @ 105°C)	20 mΩ MAXIMUM*	<b>0.13</b> mΩ	<b>-0.27</b> mΩ	<b>0.54</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>0.42</b> mΩ	<b>-0.13</b> mΩ	<b>1.86</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>3 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  2</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.99</b> mΩ	<b>12.58</b> mΩ	<b>13.51</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.01</b> mΩ	<b>-0.33</b> mΩ	<b>0.62</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>-0.15</b> mΩ	<b>-0.48</b> mΩ	<b>0.20</b> mΩ
		After Cyclic Temp and Humidity	20 mΩ MAXIMUM*	<b>-0.14</b> mΩ	<b>-0.51</b> mΩ	<b>0.64</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>-0.03</b> mΩ	<b>-0.39</b> mΩ	<b>0.52</b> mΩ

\* change from initial

WIRE TO WIRE						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  2</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>13.01</b> mΩ	<b>12.53</b> mΩ	<b>13.57</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.23</b> mΩ	<b>-0.41</b> mΩ	<b>0.66</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>0.11</b> mΩ	<b>-0.34</b> mΩ	<b>0.56</b> mΩ
		After Cyclic Temp and Humidity	20 mΩ MAXIMUM*	<b>0.10</b> mΩ	<b>-0.41</b> mΩ	<b>0.51</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>-0.29</b> mΩ	<b>-0.34</b> mΩ	<b>0.97</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>4 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  3</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.94</b> mΩ	<b>12.23</b> mΩ	<b>13.61</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.02</b> mΩ	<b>-0.51</b> mΩ	<b>0.58</b> mΩ
		After Temp Life (120 hrs. @ 105°C)	20 mΩ MAXIMUM*	<b>0.03</b> mΩ	<b>-0.50</b> mΩ	<b>0.35</b> mΩ
		Vibration	20 mΩ MAXIMUM*	<b>0.04</b> mΩ	<b>-0.29</b> mΩ	<b>0.82</b> mΩ
		Mechanical Shock	20 mΩ MAXIMUM*	<b>0.03</b> mΩ	<b>-0.53</b> mΩ	<b>0.34</b> mΩ

\* change from initial

WIRE TO WIRE						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  3</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>13.05</b> mΩ	<b>12.37</b> mΩ	<b>13.71</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.15</b> mΩ	<b>-0.25</b> mΩ	<b>0.61</b> mΩ
		After Temp Life (120 hrs. @ 105°C)	20 mΩ MAXIMUM*	<b>0.28</b> mΩ	<b>-0.21</b> mΩ	<b>0.76</b> mΩ
		Vibration	20 mΩ MAXIMUM*	<b>0.44</b> mΩ	<b>0.07</b> mΩ	<b>0.93</b> mΩ
		Mechanical Shock	20 mΩ MAXIMUM*	<b>0.47</b> mΩ	<b>0.03</b> mΩ	<b>1.72</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>5 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD, 15μ" Au						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  4</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.94</b> mΩ	<b>12.51</b> mΩ	<b>13.53</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.03</b> mΩ	<b>-0.52</b> mΩ	<b>0.90</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>0.10</b> mΩ	<b>-0.28</b> mΩ	<b>1.31</b> mΩ
		After Mixed Flowing Gas Testing (7 days Unmated)	20 mΩ MAXIMUM*	<b>1.11</b> mΩ	<b>0.21</b> mΩ	<b>4.92</b> mΩ
		After Mixed Flowing Gas Testing (3 days Mated)	20 mΩ MAXIMUM*	<b>1.40</b> mΩ	<b>0.26</b> mΩ	<b>6.39</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>1.01</b> mΩ	<b>-0.41</b> mΩ	<b>33.45</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>0.88</b> mΩ	<b>-0.17</b> mΩ	<b>29.43</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>6 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD, 30μ" Au						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  4</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.80</b> mΩ	<b>12.40</b> mΩ	<b>13.34</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.02</b> mΩ	<b>-0.42</b> mΩ	<b>0.38</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>-0.01</b> mΩ	<b>-0.42</b> mΩ	<b>0.34</b> mΩ
		After Mixed Flowing Gas Testing (7 days Unmated)	20 mΩ MAXIMUM*	<b>0.69</b> mΩ	<b>-0.25</b> mΩ	<b>2.61</b> mΩ
		After Mixed Flowing Gas Testing (3 days Mated)	20 mΩ MAXIMUM*	<b>0.71</b> mΩ	<b>0.08</b> mΩ	<b>2.79</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>0.26</b> mΩ	<b>-0.41</b> mΩ	<b>1.53</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>0.60</b> mΩ	<b>-0.30</b> mΩ	<b>2.11</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>7 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO WIRE, 15μ" Au						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>GROUP 4</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>13.05</b> mΩ	<b>12.13</b> mΩ	<b>14.26</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.01</b> mΩ	<b>-0.35</b> mΩ	<b>0.44</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>0.08</b> mΩ	<b>-0.37</b> mΩ	<b>0.46</b> mΩ
		After Mixed Flowing Gas Testing (7 days Unmated)	20 mΩ MAXIMUM*	<b>2.07</b> mΩ	<b>-0.52</b> mΩ	<b>10.28</b> mΩ
		After Mixed Flowing Gas Testing (3 days Mated)	20 mΩ MAXIMUM*	<b>1.61</b> mΩ	<b>0.41</b> mΩ	<b>5.39</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>3.23</b> mΩ	<b>0.28</b> mΩ	<b>33.62</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>2.67</b> mΩ	<b>0.20</b> mΩ	<b>12.65</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>8 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO WIRE, 30μ" Au						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  4</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.63</b> mΩ	<b>12.00</b> mΩ	<b>13.38</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.14</b> mΩ	<b>-0.31</b> mΩ	<b>0.62</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>0.07</b> mΩ	<b>-0.39</b> mΩ	<b>0.55</b> mΩ
		After Mixed Flowing Gas Testing (7 days Unmated)	20 mΩ MAXIMUM*	<b>1.05</b> mΩ	<b>0.05</b> mΩ	<b>5.01</b> mΩ
		After Mixed Flowing Gas Testing (3 days Mated)	20 mΩ MAXIMUM*	<b>1.10</b> mΩ	<b>0.08</b> mΩ	<b>7.13</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>0.86</b> mΩ	<b>-0.03</b> mΩ	<b>8.26</b> mΩ
		After Reseating (3x M/U)	20 mΩ MAXIMUM*	<b>1.34</b> mΩ	<b>0.23</b> mΩ	<b>3.88</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>9 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

(Note that measured LLCR values are for one mated interface)

WIRE TO BOARD						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  5</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.90</b> mΩ	<b>12.39</b> mΩ	<b>13.34</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.06</b> mΩ	<b>-0.31</b> mΩ	<b>0.70</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>0.27</b> mΩ	<b>-0.15</b> mΩ	<b>1.08</b> mΩ
		After Thermal Cycling	20 mΩ MAXIMUM*	<b>-0.03</b> mΩ	<b>-0.37</b> mΩ	<b>0.63</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>0.12</b> mΩ	<b>-0.37</b> mΩ	<b>0.61</b> mΩ

\* change from initial

WIRE TO WIRE						
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>G R O U P  5</b>	Contact Resistance (Low Level)	Initial	13.0 mΩ Nominal no limit set	<b>12.81</b> mΩ	<b>12.00</b> mΩ	<b>13.62</b> mΩ
		After Initial Durability (Preconditioning) (25 cycles)	20 mΩ MAXIMUM*	<b>0.08</b> mΩ	<b>-0.50</b> mΩ	<b>0.62</b> mΩ
		After Temp. Life (120 hrs. @ 105 C)	20 mΩ MAXIMUM*	<b>0.22</b> mΩ	<b>-0.62</b> mΩ	<b>0.84</b> mΩ
		After Thermal Cycling	20 mΩ MAXIMUM*	<b>0.23</b> mΩ	<b>-0.48</b> mΩ	<b>0.85</b> mΩ
		After Thermal Shock	20 mΩ MAXIMUM*	<b>0.35</b> mΩ	<b>-0.54</b> mΩ	<b>1.42</b> mΩ

\* change from initial

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>10 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

15μ" Au – 40 cycles				
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	RESULTS
<b>G R O U P  7</b>	Dielectric Withstanding Voltage (DWV)	Durability (40 M/U cycles) 2200 VAC	No breakdown or flashover	PASS

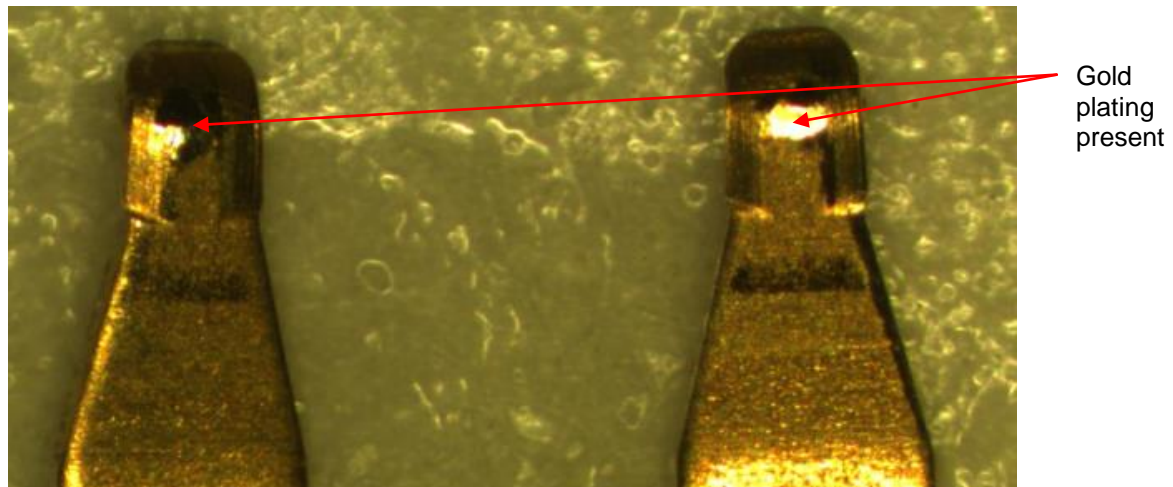


Figure 1 – Contact area shown after 40 cycles

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>11 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>

# TEST SUMMARY

## 5.1 ELECTRICAL/ENVIRONMENTAL PERFORMANCE RESULTS (cont)

15μ" Au – 250 cycles (lubricated)				
ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	RESULTS
<b>G R O U P  7</b>	Dielectric Withstanding Voltage (DWV)	Durability (250 M/U cycles) 2200 VAC	No breakdown or flashover	PASS

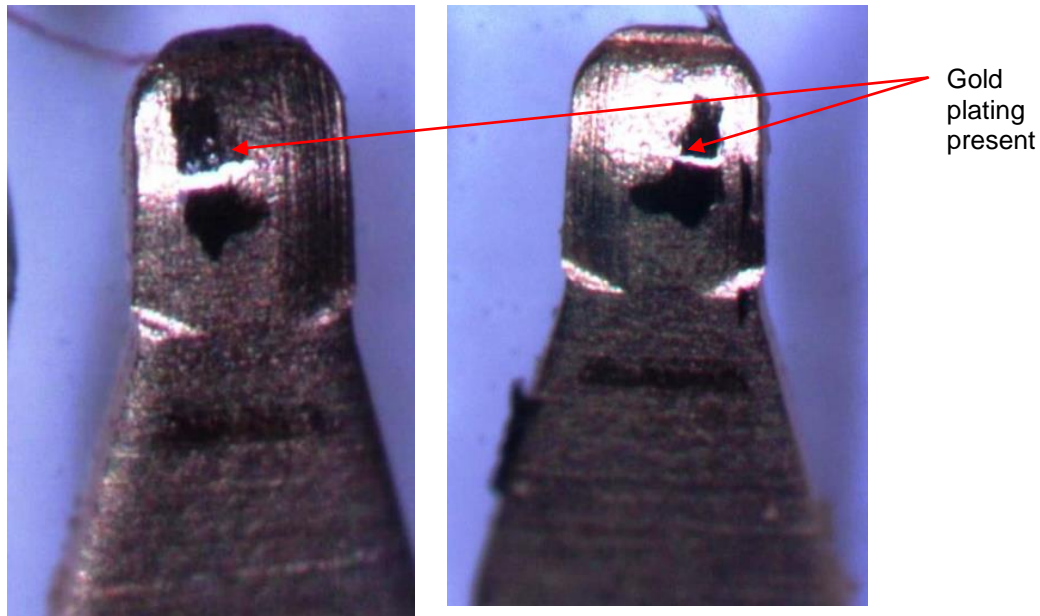


Figure 3 – Contact area shown after 250 cycles

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>12 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.2 MECHANICAL PERFORMANCE RESULTS

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>1a</b>	<b>2 circuit Connector Mate and Unmate Forces (W-B, 15<math>\mu</math>" Au) <i>**thumb latch removed**</i></b>	Initial Mating	8.0 N maximum	5.52 N	3.81 N	6.88 N
		Initial Un-Mating	4.0 N maximum	2.93 N	2.43 N	3.57 N
		Final Mating (after 40 cycles)	8.0 N maximum	4.71 N	3.40 N	5.30 N
		Final Un-Mating (after 40 cycles)	4.0 N maximum	3.51 N	1.63 N	4.06 N
<b>1b</b>	<b>2 circuit Connector Mate and Unmate Forces (W-W, 15<math>\mu</math>" Au) <i>**thumb latch removed**</i></b>	Initial Mating	8.0 N maximum	5.03 N	4.67 N	5.46 N
		Initial Un-Mating	4.0 N maximum	2.30 N	2.13 N	2.58 N
		Final Mating (after 40 cycles)	8.0 N maximum	3.59 N	3.27 N	3.87 N
		Final Un-Mating (after 40 cycles)	4.0 N maximum	2.32 N	2.10 N	2.51 N
<b>1c</b>	<b>12 circuit Connector Mate and Unmate Forces (W-B, 15<math>\mu</math>" Au) <i>**thumb latch removed**</i></b>	Initial Mating	48.0 N maximum	15.32 N	13.78 N	17.00 N
		Initial Un-Mating	24.0 N maximum	9.79 N	7.83 N	13.15 N
		Final Mating (after 40 cycles)	48.0 N maximum	16.81 N	14.74 N	20.44 N
		Final Un-Mating (after 40 cycles)	24.0 N maximum	13.76 N	11.22 N	16.38 N
<b>1d</b>	<b>12 circuit Connector Mate and Unmate Forces (W-W, 15<math>\mu</math>" Au) <i>**thumb latch removed**</i></b>	Initial Mating	48.0 N maximum	29.39 N	21.65 N	34.27 N
		Initial Un-Mating	24.0 N maximum	18.10 N	13.22 N	21.98 N
		Final Mating (after 40 cycles)	48.0 N maximum	24.12 N	19.84 N	28.23 N
		Final Un-Mating (after 40 cycles)	24.0 N maximum	19.69 N	14.57 N	23.78 N

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>13 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.2 MECHANICAL PERFORMANCE RESULTS (cont)

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
<b>1e</b>	<b>24 circuit Connector Mate and Unmate Forces (W-B, 15μ" Au) <i>**thumb latch removed**</i></b>	Initial Mating	96.0 N maximum	<b>37.93 N</b>	<b>33.42 N</b>	<b>42.50 N</b>
		Initial Un-Mating	48.0 N maximum	<b>21.82 N</b>	<b>19.98 N</b>	<b>23.35 N</b>
		Final Mating (after 40 cycles)	96.0 N maximum	<b>34.04 N</b>	<b>31.42 N</b>	<b>36.26 N</b>
		Final Un-Mating (after 40 cycles)	48.0 N maximum	<b>25.35 N</b>	<b>23.77 N</b>	<b>27.13 N</b>
<b>1f</b>	<b>24 circuit Connector Mate and Unmate Forces (W-W, 15μ" Au) <i>**thumb latch removed**</i></b>	Initial Mating	96.0 N maximum	<b>52.61 N</b>	<b>47.20 N</b>	<b>61.89 N</b>
		Initial Un-Mating	48.0 N maximum	<b>29.87 N</b>	<b>27.53 N</b>	<b>32.68 N</b>
		Final Mating (after 40 cycles)	96.0 N maximum	<b>43.80 N</b>	<b>40.78 N</b>	<b>45.15 N</b>
		Final Un-Mating (after 40 cycles)	48.0 N maximum	<b>36.45 N</b>	<b>32.49 N</b>	<b>39.52 N</b>

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: <b>109530</b> DATE: <b>2016 / 10 / 19</b>	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>14 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 5.2 MECHANICAL PERFORMANCE RESULTS (cont)

ITEM	DESCRIPTION	TREATMENT	REQUIREMENT	MEAN	MINIMUM	MAXIMUM
2	Terminal Retention Force (in housing)	-----	24.5 N per contact minimum	36.4 N	35.4 N	37.9 N
3	Terminal Insertion Force (in housing)	-----	14.7 N per contact maximum	2.9 N	2.2 N	4.2 N
4	Wire Pullout Force (from terminal)	20 awg	57.8 N minimum	107.4 N	97.0 N	116.0 N
		22 awg	35.6 N minimum	80.7 N	71.8 N	86.0 N
		24 awg	22.2 N minimum	50.45 N	46.0 N	56.0 N
		26 awg	13.3 N minimum	28.7 N	24.0 N	31.0 N
		28 awg	8.9 N minimum	17.1 N	15.0 N	19.0 N
		30 awg	6.6 N minimum	9.4 N	9.0 N	10.0 N
5	Normal Force (nominal deflection)	Initial	50 g per contact beam minimum	134.8 g	120.8 g	143.3 g
		After one cycle	50 g per contact beam minimum	134.3 g	121.8 g	143.6 g

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>15 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 6.0 APPENDIX 1

### 6.1 TEST SEQUENCES

GROUP 1	GROUP 2	GROUP 3	GROUP 4	GROUP 5	GROUP 7
Visual Exam	Visual Exam	Visual Exam	Visual Exam	Visual Exam	Visual Exam
LLCR	LLCR	LLCR	LLCR	LLCR	LLCR
Preconditioning Durability (25 M/U cycles)	Preconditioning Durability (25 M/U cycles)	Preconditioning Durability (25 M/U cycles)	Preconditioning Durability (25 M/U cycles)	Preconditioning Durability (25 M/U cycles)	Durability (40 M/U cycles)
LLCR	LLCR	Temp Life (120 hrs @ 105°)	LLCR	LLCR	LLCR
Temp Life (240 hrs @ 105°)	Thermal Shock	LLCR	Temp Life (120 hrs @ 105°)	Temp Life (120 hrs @ 105°)	DWV
LLCR	LLCR	Vibration	LLCR	LLCR	Visual Exam
Reseating	Cyclic Temp and Humidity	LLCR	MFG (7 days Unmated)	Thermal Cycling	
LLCR	LLCR	Mechanical Shock	LLCR	LLCR	
	Reseating	LLCR	MFG (3 days Mated)	Thermal Shock	
	LLCR		LLCR	LLCR	
			Thermal Shock	Reseating	
			LLCR	LLCR	
			Reseating		
			LLCR		

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>16 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 6.2 TEST PROCEDURES

<u>ITEM</u>	<u>TEST CONDITION</u>
LOW LEVEL CONTACT RESISTANCE (LLCR)	per EIA-364-TP-23
INITIAL MATING FORCE	per EIA-364-TP-13
INITIAL UN-MATING FORCE	per EIA-364-TP-13
DURABILITY	per EIA-364-TP-09
RANDOM VIBRATION	per EIA-364-TP-28, Test Cond. VII
MECHANICAL SHOCK	per EIA-364-TP-27 Peak Value: 50 G; Duration: 11 mSec.; Waveform: Half Sine; # Shocks Direction: 3 shocks/3 axes (18 total)
NORMAL FORCE	per EIA-364-04 (perpendicular force)
THERMAL AGING (Temp life)	per EIA-364-TP-17, method A
THERMAL SHOCK	per EIA-364-TP-32
CYCLIC HUMIDITY	per EIA-364-TP-31 Test Temp: +40° ± 2° C Relative Humidity: 90 to 95%; Test Duration: 96 hours
MIXED FLOWING GAS (MFG)	per EIA-364-TP-65, Option 2, Class IIA
Dielectric Withstanding Voltage (DWV)	per EIA-364-TP-20 Method B
Insulation Resistance	per EIA-364-TP-21
Current Carrying Capacity (CCC)	per EIA-364-TP-70 Method 2

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>17 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>



# TEST SUMMARY

## 7.0 REVISION HISTORY

Revision Level:	Created / Revised By:	Revision Description:	Date of Revision
A	T. Gregori	Initial "A" Release	7/09/08
B	T. Gregori	Revised Group 4 data based on test results, section 5.1	7/28/08
C	T. Gregori	T-Rise table added; Group 7 250 cycle table added	11/20/08
D	T. Gregori	Revised mate / un-mate force; added total forces for 2, 12 and 24 ckts (items 1a thru 1f)	8/5/09
D1	JDFOX	Add series detail to sections 2.1 & 2.1.1	10/19/16

REVISION: <b>D1</b>	ECR/ECN INFORMATION: EC No: 109530 DATE: 2016 / 10 / 19	TITLE: <b>TEST SUMMARY FOR 46235 LOW FORCE MICRO-FIT CONNECTOR SYSTEM</b>	SHEET No. <b>18 of 18</b>
DOCUMENT NUMBER: <b>TS-46235-001</b>	CREATED / REVISED BY: <b>JDFOX</b>	CHECKED BY: <b>SSOUSEK</b>	APPROVED BY: <b>FSMITH</b>